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U.S. UTILITY Patent Application

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PATENT NUMBER and

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APPL NUM 10060569	FILING DATE 01/29/2002	CLASS 438	SUBCLASS	GAU 1763	EXAMINER Gouldreau
APPLICANTS: Kobayashi Migaku;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CON OF 09/640,959 08/16/2000, now abandoned					
**FOREIGN APPLICATIONS VERIFIED: JAPAN 230500/1999 08/17/1999					
FG-PUB DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO 92911-02 N230500C1			
TITLE : Method of fabricating a semiconductor device					
FORMAL DRAWINGS					
ISSUE FEE IN FILE					

NOTICE OF ALLOWANCE MAILED 03/25/03		CLAIMS ALLOWED Total Claims 27 Print Claim for 0.6	
ISSUE FEE 276 Amount Due 1600.00 Date Paid 6-24-03		DRAWING Sheets Drwg. 12 Figs. Drwg. 34 Print Fig. 80	
<input type="checkbox"/> TERMINAL DISCLAIMER		Primary Examiner J. Gouldreau 3-03 PREPARED FOR ISSUE Application Examiner M. Whist	
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